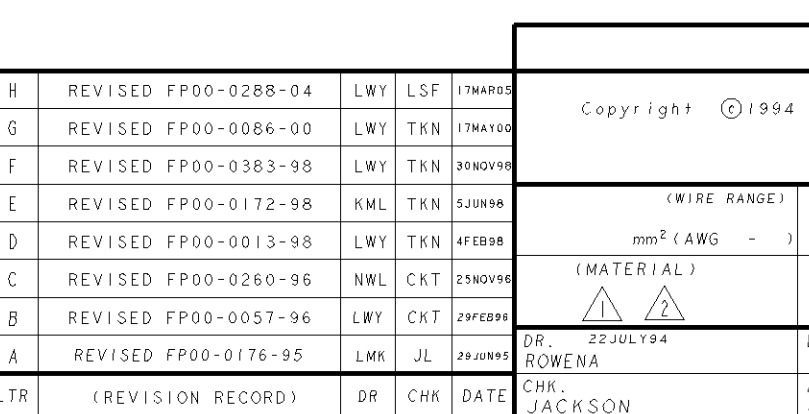
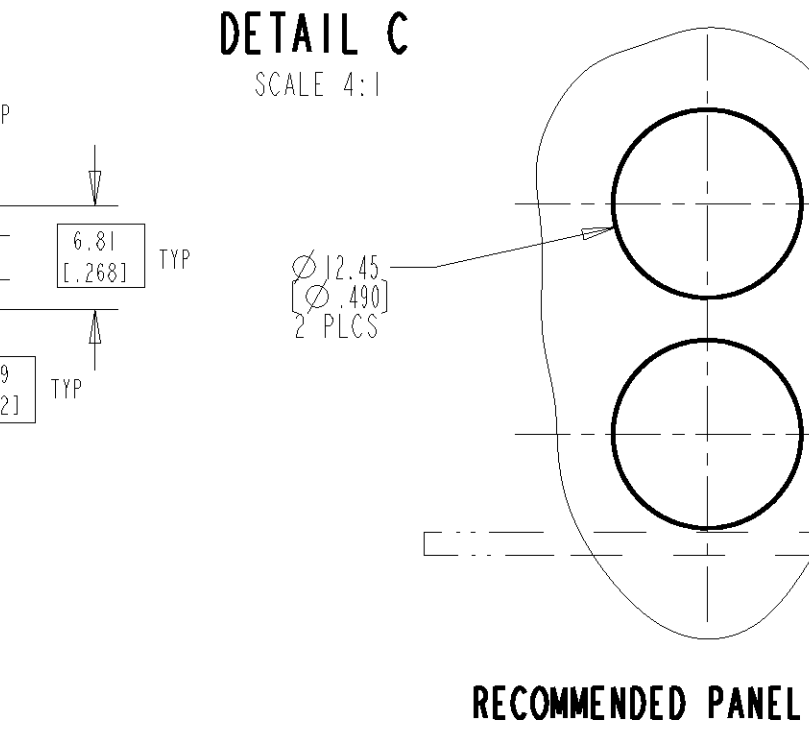
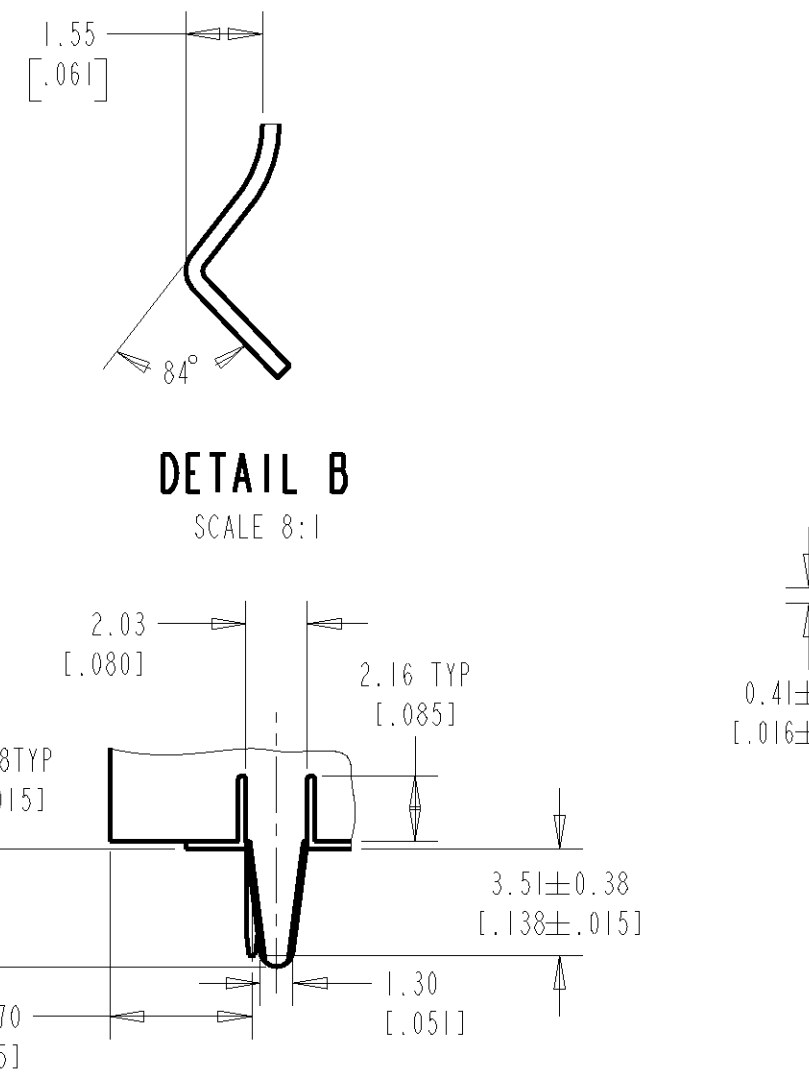
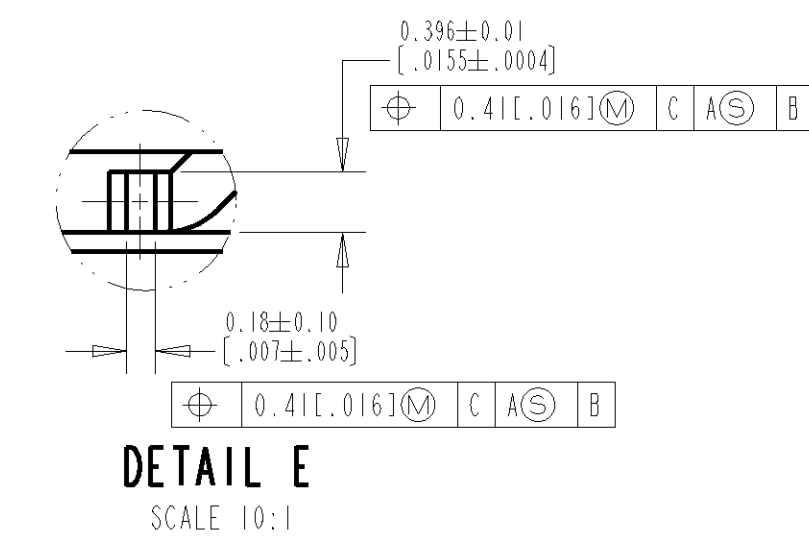
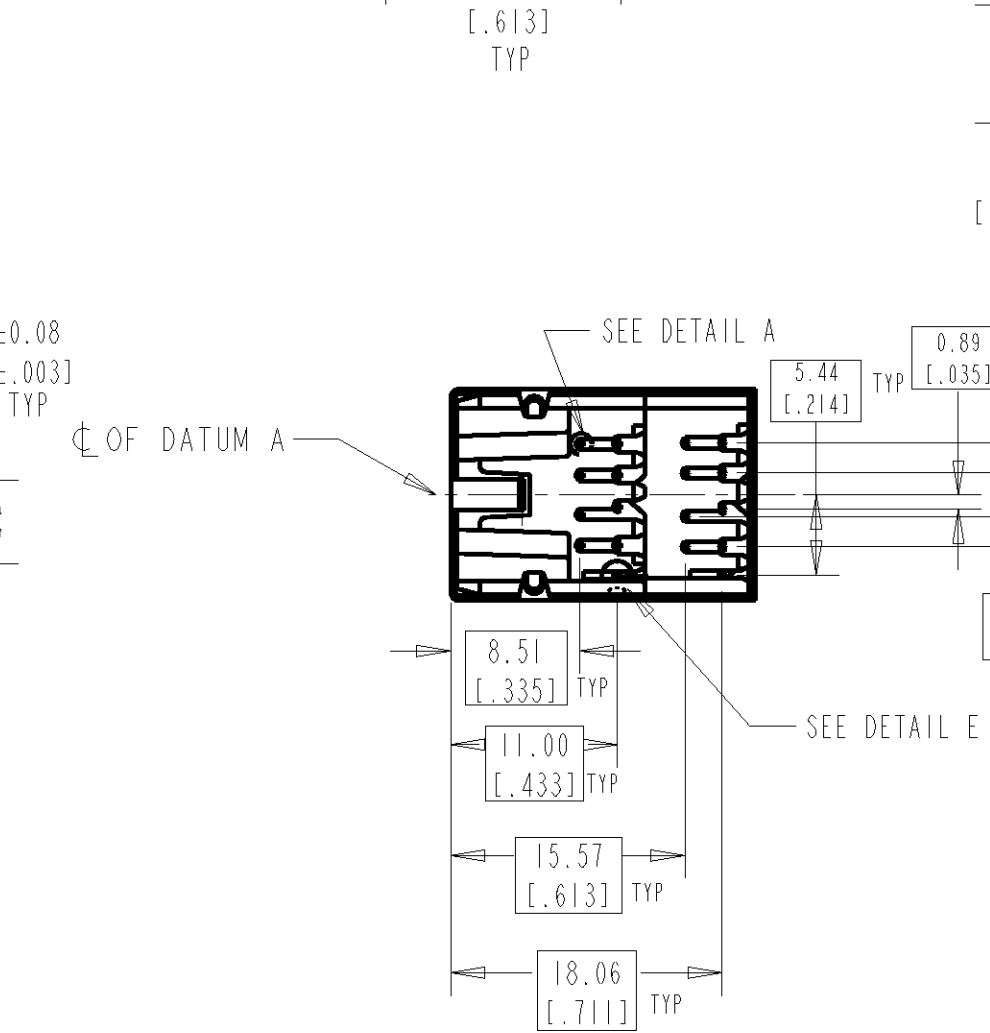
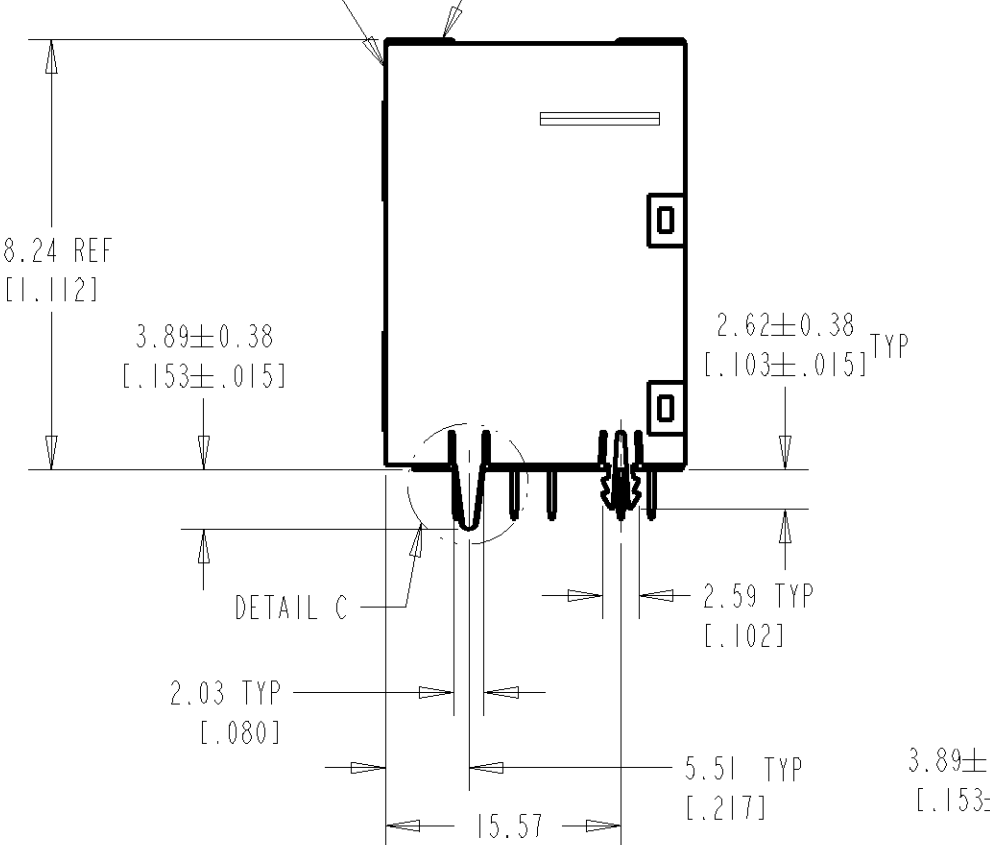
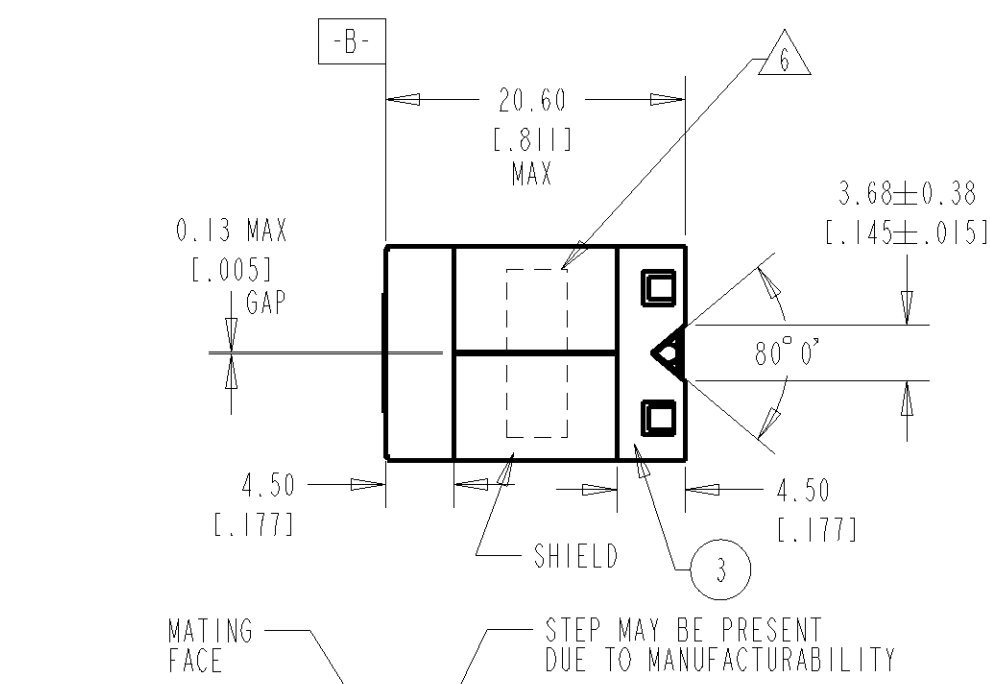
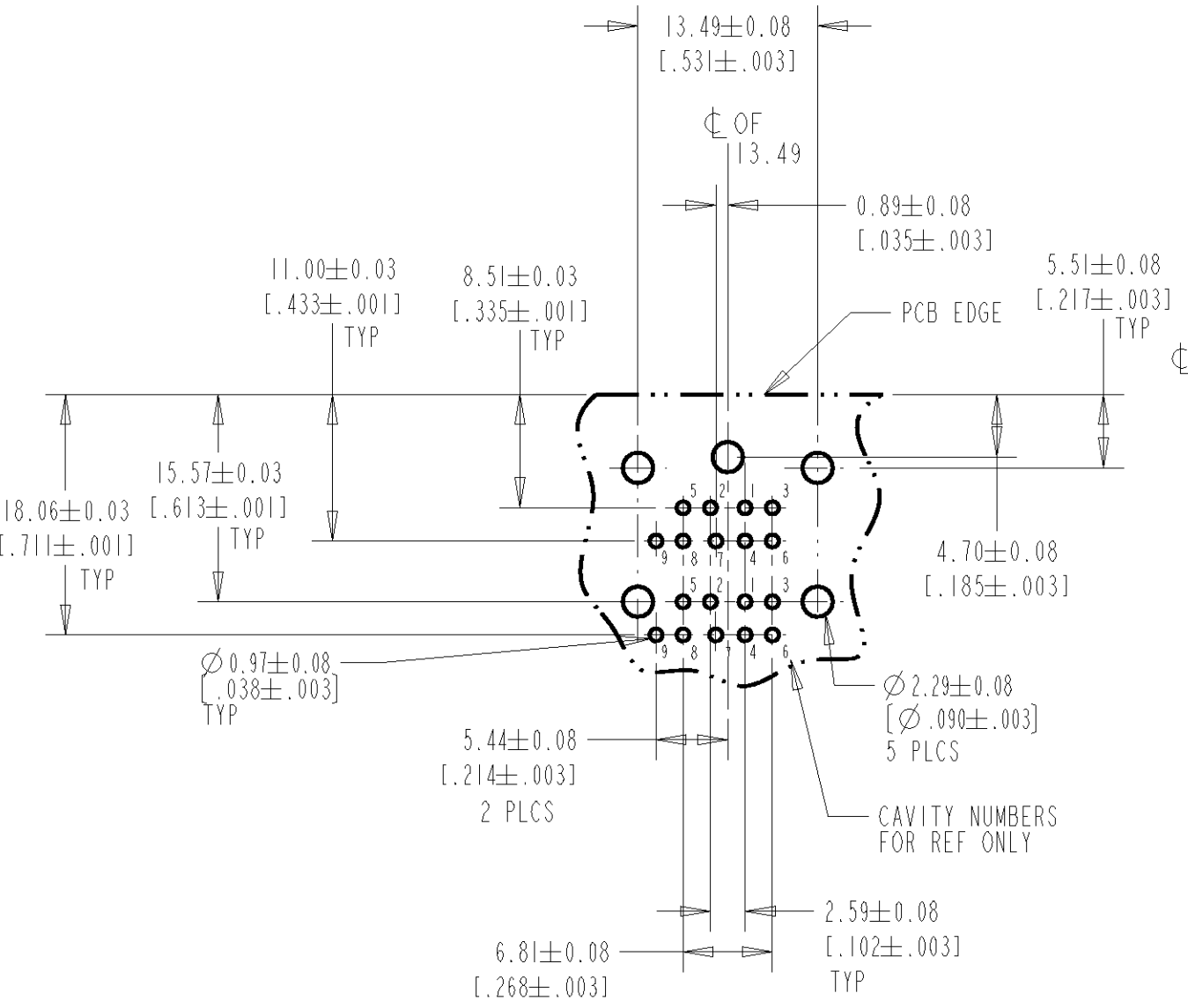
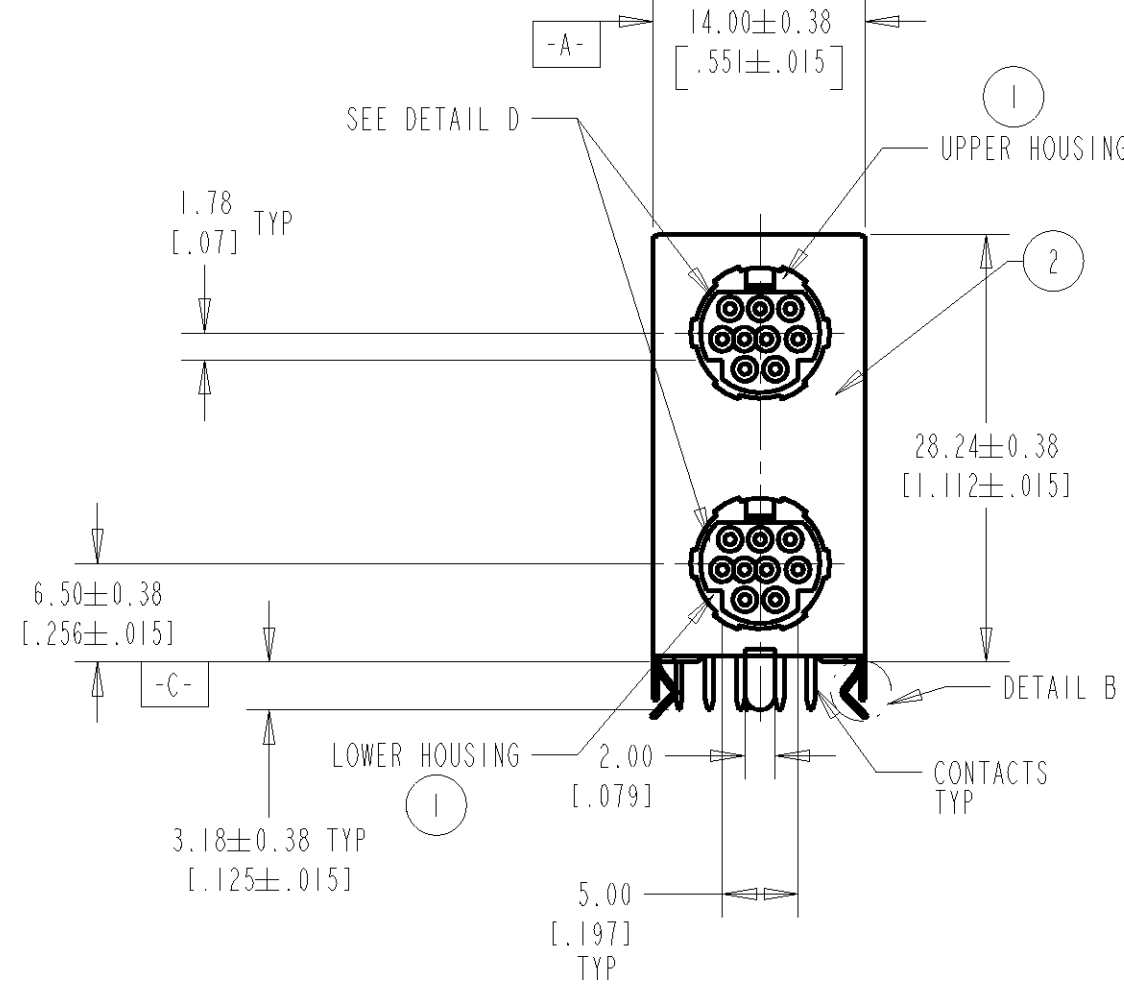
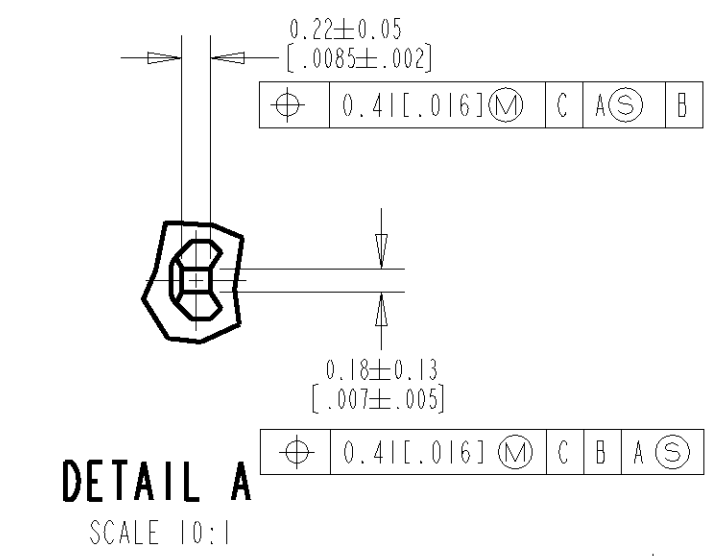
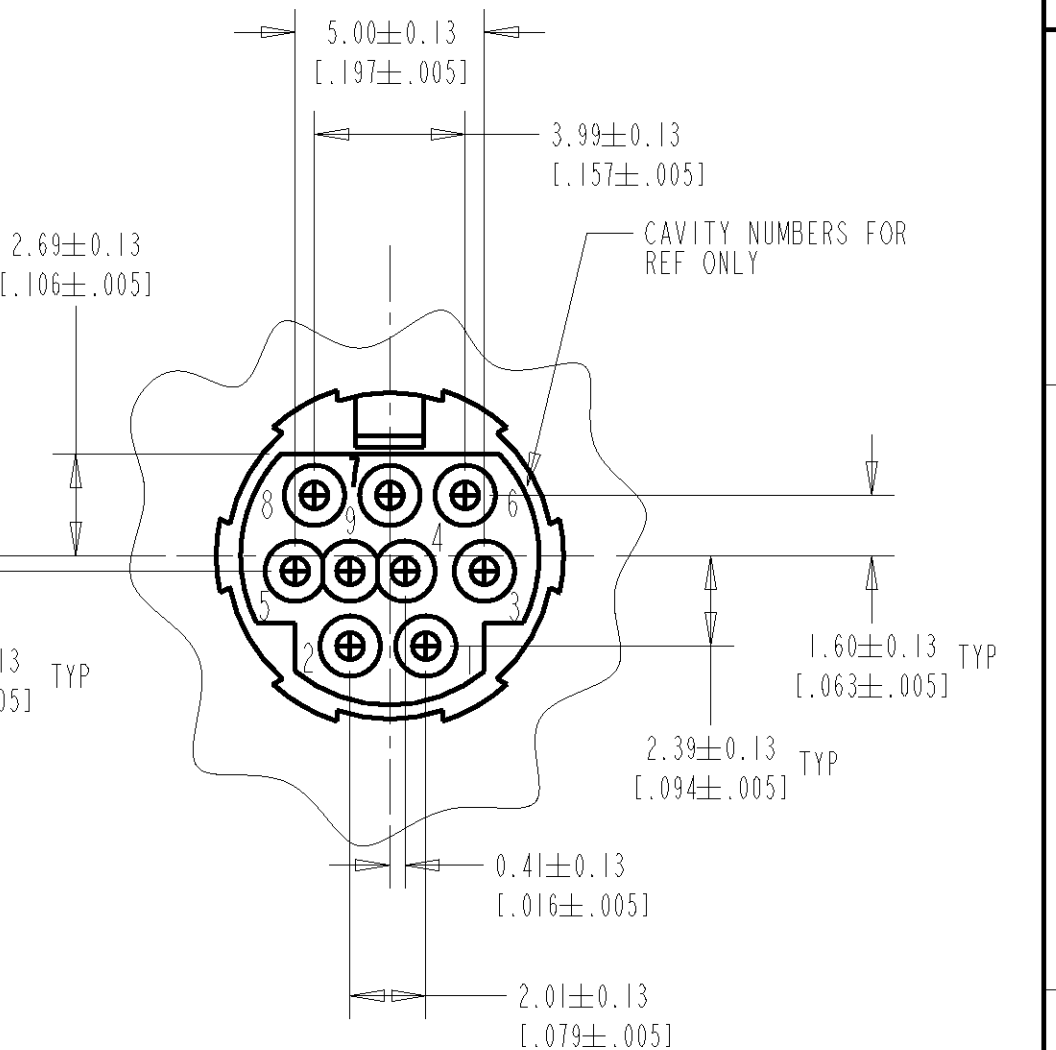




- NOTES:
- 1 CONTACT: COPPER ALLOY
 - 2 HOUSING: POLYMER, UL94V-0 RATED, GRAY
 - 3 CONTACT PLATING: 0.75um [.000030] MIN GOLD FOR A LENGTH OF 1.52 [.060] MIN ON INSIDE FROM MATING END, 3.05 um [.000120] MIN TIN-LEAD FOR A LENGTH OF 3.56 [.140] MIN FROM OPPOSITE END, BOTH OVER 1.27um [.000050] MIN NICKEL
 - 4 SHIELD PLATING: 2.54um [.000100] MIN TIN
 - 5. PRODUCT SPEC.: 108-51010
APPLICATION SPEC.: 114-51004
 - 6 DATE CODE TO BE PRINTED AT APPROX. THIS LOCATION
 - 7 TUBE PACKAGING



DETAIL I
SCALE 5:1

RECEPTACLE ASSEMBLY.
9 POSN OVER 9 POSN, RIGHT ANGLE.
STACKABLE, MINIATURE CIRCULAR DIN

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AMP AMP MANUFACTURING (SINGAPORE) PTE. LTD.

(WIRE RANGE)	(INSULATION DIA.)	(NAME)
mm ² (AWG -)	-	mm ²
(MATERIAL)	(FINISH)	
1 2	3 4	
DR. 22JULY94 ROWENA	DE. A.SOH	
CHK. JACKSON	APP. SF LEONG	
(REVISION RECORD)	DR	CHK
DATE		

(GENERAL TOLERANCE)	SIZE	LOC	(No.)
0 < + ≤ 10 : ±0.2 10 < + ≤ 30 : ±0.25 30 < + ≤ 100 : ±0.3 ANGLES : ±3°	A2	DY	84230
(SCALE)	REV.	SHEET	
2:1	H	1 OF 1	

OBSELETE	I	OBSELETE	DESCRIPTION	ITEM NO.
OBSELETE	I	OBSELETE	BACK COVER	3
OBSELETE	I	OBSELETE	SHIELD, FIFTH BOARD MOUNT	2
OBSELETE	I	OBSELETE	HIGH TEMP. HOUSING 9/9	1
OBSELETE	I	OBSELETE	LOW TEMP. HOUSING 9/9	1

H	REVISED FP00-0288-04	LWY	LSF	17MAR05
G	REVISED FP00-0086-00	LWY	TKN	17MAY00
F	REVISED FP00-0383-98	LWY	TKN	30NOV98
E	REVISED FP00-0172-98	KML	TKN	5JUN98
D	REVISED FP00-0013-98	LWY	TKN	4FEB98
C	REVISED FP00-0260-96	NWL	CKT	25NOV96
B	REVISED FP00-0057-96	LWY	CKT	29FEB96
A	REVISED FP00-0176-95	LMR	JL	29JUN95
LTR	(REVISION RECORD)	DR	CHK	DATE